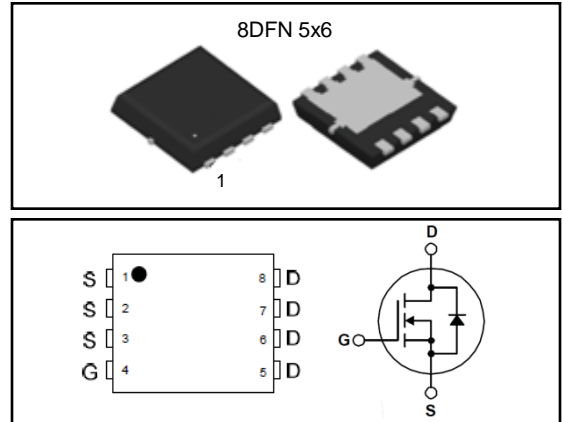


HRLF150N10K

100V N-Channel Trench MOSFET

FEATURES

- ❑ $BV_{DSS} = 100\text{ V}$
- ❑ $I_D = 50\text{ A}$
- ❑ Unrivalled Gate Charge : 80 nC (Typ.)
- ❑ Lower $R_{DS(ON)}$: 13 m Ω (Typ.) @ $V_{GS}=10\text{V}$
- ❑ Lower $R_{DS(ON)}$: 14 m Ω (Typ.) @ $V_{GS}=4.5\text{V}$
- ❑ 100% Avalanche Tested



Absolute Maximum Ratings $T_J=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Units | |
|----------------|---|---------------------------|------------------|---|
| V_{DSS} | Drain-Source Voltage | 100 | V | |
| V_{GS} | Gate-Source Voltage | ± 20 | V | |
| I_D | Drain Current | $T_C = 25^\circ\text{C}$ | 50 | A |
| | | $T_C = 100^\circ\text{C}$ | 32 | A |
| I_{DM} | Pulsed Drain Current (Note 1) | 110 | A | |
| E_{AS} | Single Pulsed Avalanche Energy (Note 2) | 190 | mJ | |
| P_D | Power Dissipation | $T_C = 25^\circ\text{C}$ | 74 | W |
| | | $T_A = 25^\circ\text{C}$ | 2.0 | W |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ | |

Thermal Resistance Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-----------------|------------------------------------|------|------|--------------------|
| $R_{\theta JC}$ | Junction-to-Case | -- | 1.7 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Junction-to-Ambient (steady state) | -- | 62 | $^\circ\text{C/W}$ |

Electrical Characteristics $T_J=25\text{ }^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|---|---|---|-----|------|-----------|---------------|
| On Characteristics | | | | | | |
| V_{GS} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 1.0 | -- | 2.4 | V |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS} = 10\ \text{V}, I_D = 20\ \text{A}$ | -- | 13 | 15 | m Ω |
| | | $V_{GS} = 4.5\ \text{V}, I_D = 15\ \text{A}$ | -- | 14 | 20 | m Ω |
| g_{FS} | Forward Transconductance | $V_{DS} = 5, I_D = 20\ \text{A}$ | -- | 50 | -- | S |
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0\ \text{V}, I_D = 250\ \mu\text{A}$ | 100 | -- | -- | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 80\ \text{V}, V_{GS} = 0\ \text{V}$ | -- | -- | 1 | μA |
| | | $V_{DS} = 80\ \text{V}, T_J = 125\text{ }^\circ\text{C}$ | -- | -- | 100 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{GS} = \pm 20\ \text{V}, V_{DS} = 0\ \text{V}$ | -- | -- | ± 100 | nA |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = 25\ \text{V}, V_{GS} = 0\ \text{V}, f = 1.0\ \text{MHz}$ | -- | 4000 | -- | pF |
| C_{oss} | Output Capacitance | | -- | 290 | -- | pF |
| C_{riss} | Reverse Transfer Capacitance | | -- | 150 | -- | pF |
| R_g | Gate Resistance | $V_{GS} = 0\ \text{V}, V_{DS} = 0\ \text{V}, f = 1\ \text{MHz}$ | -- | 1.2 | -- | Ω |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-On Time | $V_{DS} = 50\ \text{V}, I_D = 30\ \text{A}, R_G = 6\ \Omega$ | -- | 30 | -- | ns |
| t_r | Turn-On Rise Time | | -- | 30 | -- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 180 | -- | ns |
| t_f | Turn-Off Fall Time | | -- | 25 | -- | ns |
| Q_g | Total Gate Charge | $V_{DS} = 80\ \text{V}, I_D = 30\ \text{A}, V_{GS} = 10\ \text{V}$ | -- | 80 | -- | nC |
| Q_{gs} | Gate-Source Charge | | -- | 10 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | -- | 15 | -- | nC |
| Source-Drain Diode Maximum Ratings and Characteristics | | | | | | |
| I_S | Continuous Source-Drain Diode Forward Current | | -- | -- | 50 | A |
| I_{SM} | Pulsed Source-Drain Diode Forward Current | | -- | -- | 110 | |
| V_{SD} | Source-Drain Diode Forward Voltage | $I_S = 30\ \text{A}, V_{GS} = 0\ \text{V}$ | -- | -- | 1.3 | V |
| t_{rr} | Reverse Recovery Time | $I_S = 30\ \text{A}, V_{GS} = 0\ \text{V}, di_F/dt = 100\ \text{A}/\mu\text{s}$ | -- | 50 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 80 | -- | nC |

Notes :

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L=1\text{mH}, I_{AS}=17\text{A}, V_{DD}=25\text{V}, R_G=25\Omega$, Starting $T_J=25\text{ }^\circ\text{C}$

Typical Characteristics

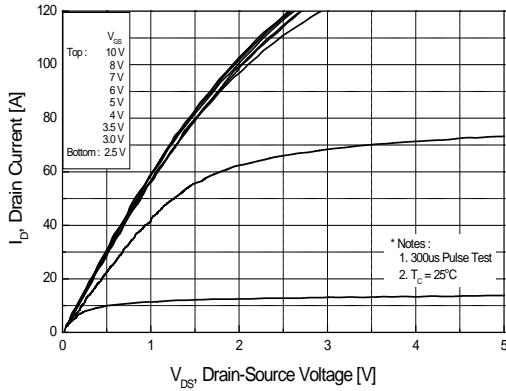


Figure 1. On Region Characteristics

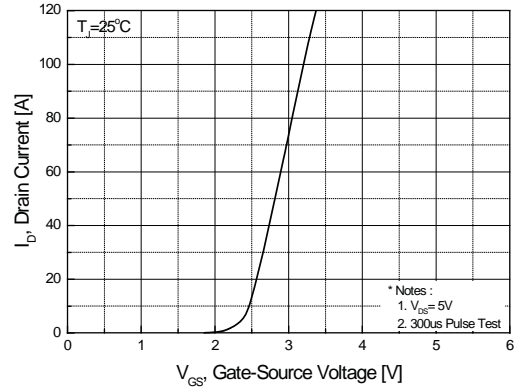


Figure 2. Transfer Characteristics

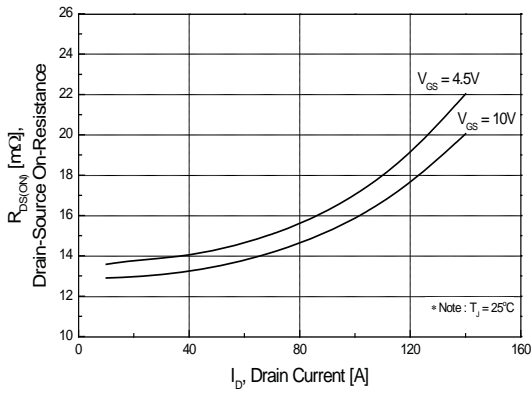


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

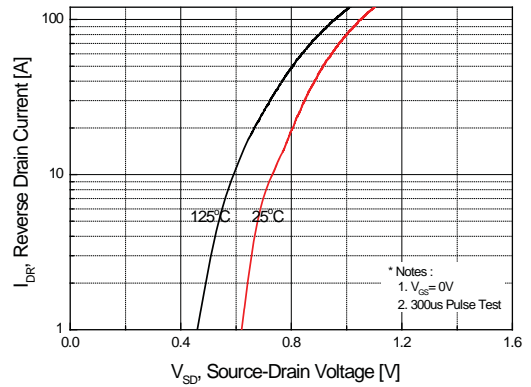


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

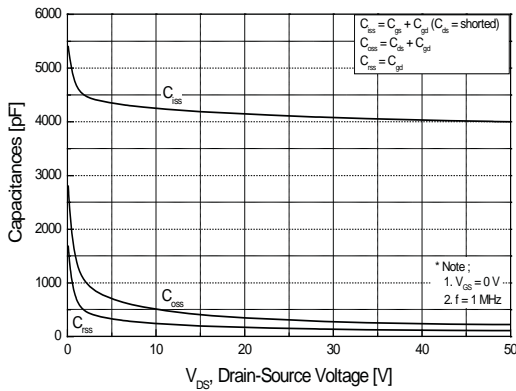


Figure 5. Capacitance Characteristics

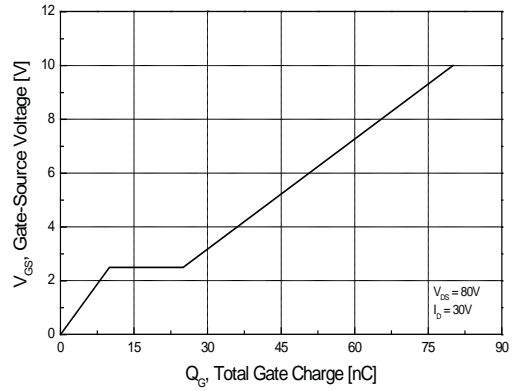


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

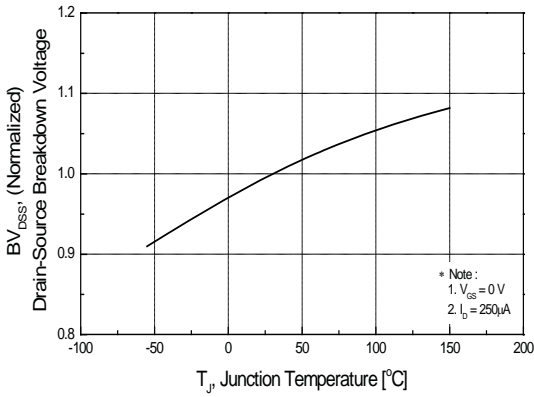


Figure 7. Breakdown Voltage Variation vs Temperature

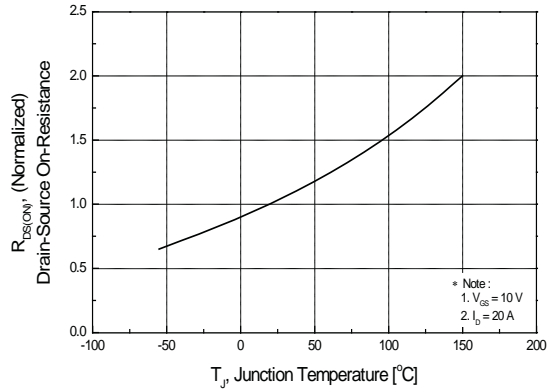


Figure 8. On-Resistance Variation vs Temperature

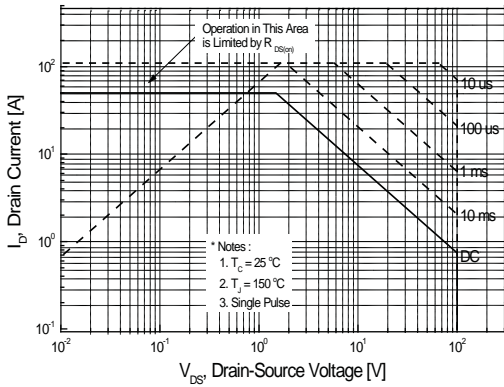


Figure 9. Maximum Safe Operating Area

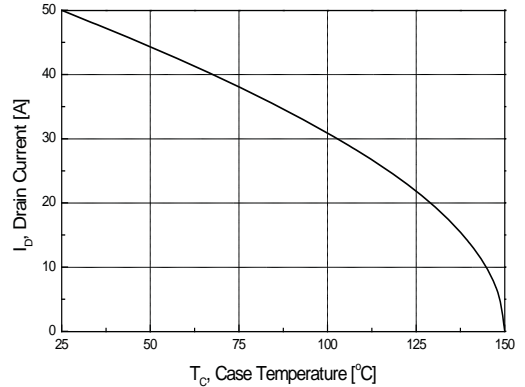


Figure 10. Maximum Drain Current vs Case Temperature

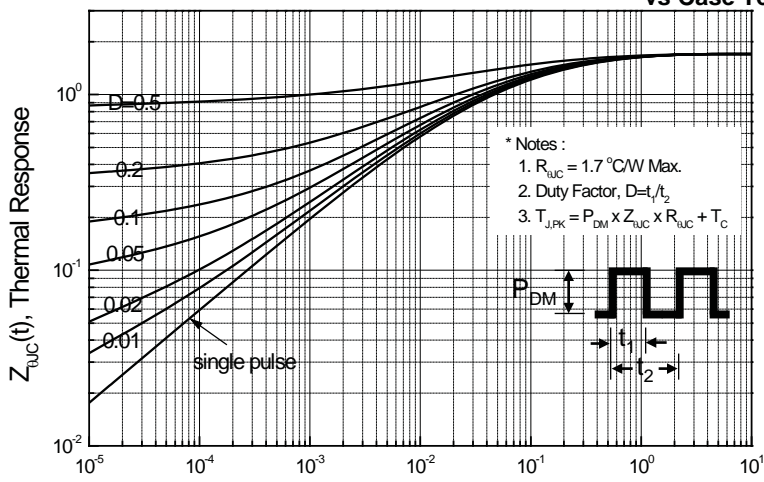


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform



Fig 13. Resistive Switching Test Circuit & Waveforms



Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

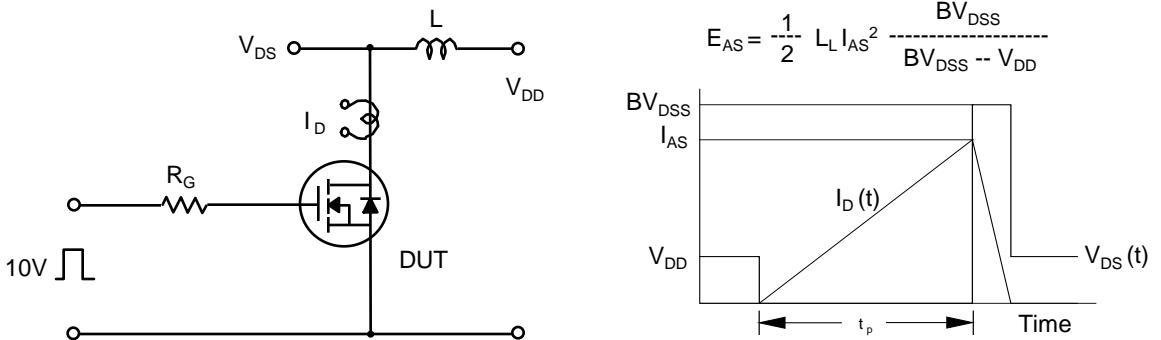
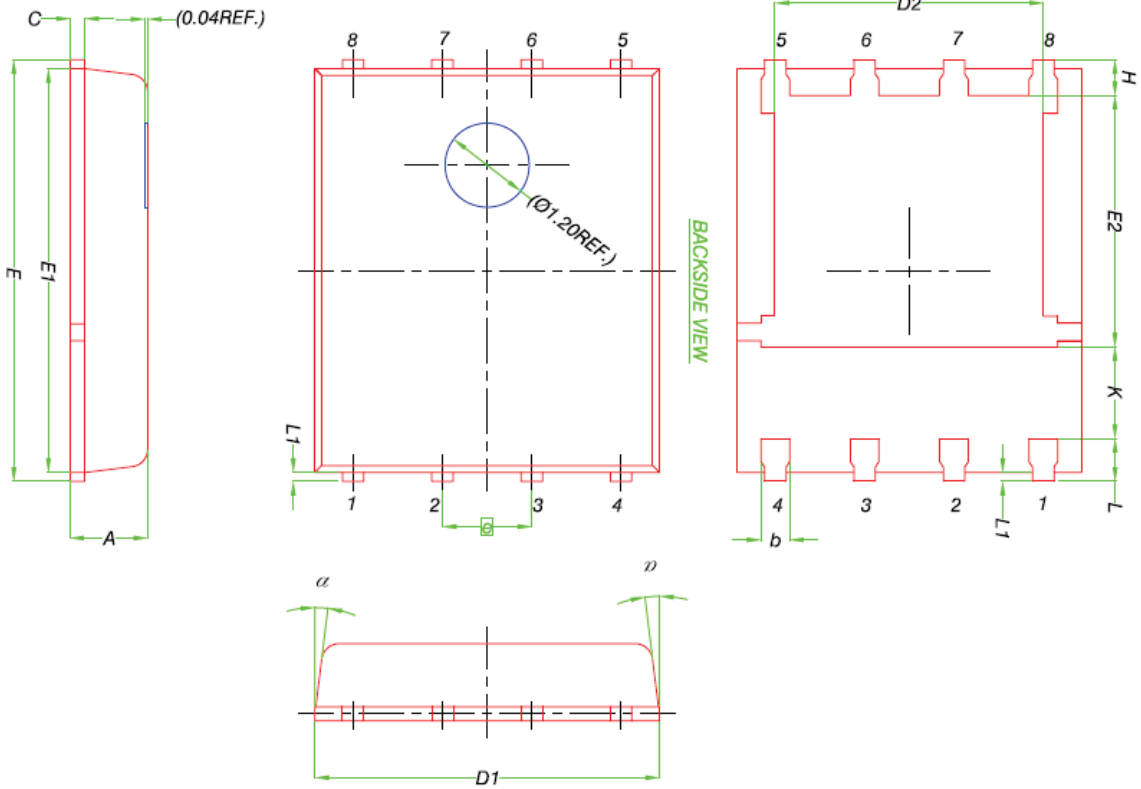


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimension

8DFN 5x6



| DIM. | MILLIMETERS | | |
|------|-------------|------|------|
| | MIN. | NOM. | MAX. |
| A | 0.90 | 1.00 | 1.10 |
| b | 0.33 | 0.41 | 0.51 |
| C | 0.20 | 0.25 | 0.30 |
| D1 | 4.80 | 4.90 | 5.00 |
| D2 | 3.61 | 3.81 | 3.96 |
| E | 5.90 | 6.00 | 6.10 |
| E1 | 5.70 | 5.75 | 5.80 |
| E2 | 3.38 | 3.58 | 3.78 |
| e | 1.27 BSC | | |
| H | 0.41 | 0.51 | 0.61 |
| K | 1.10 | - | - |
| L | 0.51 | 0.61 | 0.71 |
| L1 | 0.06 | 0.13 | 0.20 |
| α | 0° | - | 12° |

